

# N-Channel Super Trench Power MOSFET

#### Description

The RM130N100HD uses **Super Trench** technology that is uniquely optimized to provide the most efficient high frequency switching performance. Both conduction and switching power losses are minimized due to an extremely low combination of  $R_{DS(ON)}$  and  $Q_g$ . This device is ideal for high-frequency switching and synchronous rectification.

#### **General Features**

- V<sub>DS</sub> =100V,I<sub>D</sub> =130A
- $R_{DS(ON)}$  <5.4m $\Omega$  @ V<sub>GS</sub>=10V
- Excellent gate charge x R<sub>DS(on)</sub> product
- Very low on-resistance R<sub>DS(on)</sub>
- Pb-free lead plating
- 100% UIS tested

### Application

- DC/DC Converter
- Ideal for high-frequency switching and synchronous rectification
- Halogen-free



Schematic diagram



TO-263-2L top view

#### 100% UIS TESTED! Δ 100% Vds TESTED!

#### **Package Marking and Ordering Information**

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
130N100	RM130N100HD	TO-263-2L	-	-	-

#### Absolute Maximum Ratings (T<sub>c</sub>=25<sup>°</sup>C unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V <sub>DS</sub>	100	V
Gate-Source Voltage	V <sub>GS</sub>	±20	V
Continuous Drain Current (T <sub>a</sub> =25°C)	ID	130	A
Continuous Drain Current (T <sub>a</sub> =100°C)	I <sub>D</sub>	84	A
Pulsed Drain Current <sup>(1)</sup>	I <sub>DM</sub>	440	A
Single Pulsed Avalanche Energy <sup>(2)</sup>	E <sub>AS</sub>	225	mJ
Power Dissipation	PD	192	W
Thermal Resistance from Junction to Case	R <sub>θJC</sub>	0.65	°C/W
Junction Temperature	TJ	150	°C
Storage Temperature	T <sub>STG</sub>	-55~ +150	Ĉ

## Electrical Characteristics (Tc=25°C unless otherwise noted)

Parameter	Symbol	Test Condition	Min	Туре	Мах	Unit
Static Characteristics						
Drain-source breakdown voltage	V <sub>(BR)DSS</sub>	V <sub>GS</sub> = 0V, I <sub>D</sub> =250µA	100	-	-	V
Zero gate voltage drain current	DSS	V <sub>DS</sub> =100V, V <sub>GS</sub> = 0V	-	-	1	μA
Gate-body leakage current	GSS	$V_{GS} = \pm 20V, V_{DS} = 0V$	-	-	±100	nA
Gate threshold voltage <sup>(3)</sup>	V <sub>GS(th)</sub>	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =250µA	2	3	4	V
Drain-source on-resistance <sup>(3)</sup>	R <sub>DS(on)</sub>	V <sub>GS</sub> =10V, I <sub>D</sub> =20A	-	4.5	5.4	mΩ
Gate Resistance	R <sub>G</sub>	f =1MHz	-	3.5	-	Ω
Dynamic characteristics		·	•			
Input Capacitance	C <sub>iss</sub>		-	3244	-	pF
Output Capacitance	C <sub>oss</sub>	V <sub>DS</sub> =50V, V <sub>GS</sub> =0V, f =1MHz	-	1075	-	
Reverse Transfer Capacitance	C <sub>rss</sub>		-	52	-	
Switching characteristics	•	•	•			
Turn-on delay time	t <sub>d(on)</sub>	$V_{DD}$ =50V, RL=2.5 $\Omega$ $V_{GS}$ =10V, R <sub>G</sub> =6 $\Omega$	-	22	-	ns
Turn-on rise time	tr		-	36	-	
Turn-off delay time	t <sub>d(off)</sub>		-	49	-	
Turn-off fall time	t <sub>f</sub>		-	31	-	
Total Gate Charge	Qg		-	51	-	
Gate-Source Charge	Qgs	VDS=50V, ID=20A,	-	15	-	nC
Gate-Drain Charge	Qgd	- VGS-10V	-	13	-	
Source-Drain Diode characteristics						
Diode Forward voltage <sup>(3)</sup>	V <sub>DS</sub>	V <sub>GS</sub> =0V, I <sub>S</sub> =20A	-	-	1.2	V
Diode Forward current <sup>(4)</sup>	Is		-	-	120	А
Reverse recovery time	Trr	Is=15A,V <sub>GS</sub> =0V,dI <sub>F</sub> /dt=100A/us		58		ns
Reverse recovery charge	Qrr	Is=15A,V <sub>GS</sub> =0V,dI <sub>F</sub> /dt=100A/us		90		nC

#### Notes:

- 1. Repetitive Rating: pulse width limited by maximum junction temperature
- 2. EAS Condition:T\_J=25  $^\circ C$  ,V\_DD=50V,R\_G=25  $\Omega$  ,L=0.5mH
- 3. Pulse Test: pulse width $\leq$ 300µs, duty cycle $\leq$ 2%
- 4. Surface Mounted on FR4 Board,t≤10 sec



## Test Circuit 1) E<sub>AS</sub> test Circuit



# 2) Gate charge test Circuit



3) Switch Time Test Circuit





## **RATING AND CHARACTERISTICS CURVES (RM130N100HD)**

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## RATING AND CHARACTERISTICS CURVES (RM130N100HD)



# TO-263-2L Package Information



Symbol	Dimensions I	n Millimeters	Dimensions In Inches		
	Min.	Max.	Min.	Max.	
А	4.470	4.670	0.176	0.184	
A1	0.000	0.150	0.000	0.006	
В	1.170	1.370	0.046	0.054	
b	0.710	0.910	0.028	0.036	
b1	1.170	1.370	0.046	0.054	
С	0.310	0.530	0.012	0.021	
c1	1.170	1.370	0.046	0.054	
D	10.010	10.310	0.394	0.406	
E	8.500	8.900	0.335	0.350	
e	2.540 TYP.		0.100 TYP.		
e1	4.980	5.180	0.196	0.204	
L	15.050	15.450	0.593	0.608	
L1	5.080	5.480	0.200	0.216	
L2	2.340	2.740	0.092	0.108	
L3	1.300	1.700	0.051	0.067	
V	5.600 REF		0.220 REF		

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